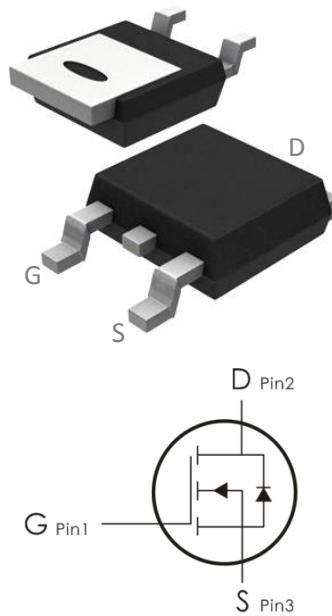


## Description:

This N-Channel MOSFET uses advanced trench technology and design to provide excellent  $R_{DS(on)}$  with low gate charge. It can be used in a wide variety of applications.



## Features:

- 1)  $V_{DS}=400V, I_D=6A, R_{DS(ON)}<1000m\Omega @V_{GS}=10V$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra  $R_{DS(ON)}$ .
- 5) Excellent package for good heat dissipation.

## Absolute Maximum Ratings: ( $T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain-Source Voltage	400	V
$V_{GS}$	Gate-Source Voltage	$\pm 30$	V
$I_D$	Continuous Drain Current- $T_C=25^\circ C$ <sup>1</sup>	6	A
	Continuous Drain Current- $T_C=100^\circ C$ <sup>1</sup>	3.6	
	Pulsed Drain Current <sup>2</sup>	---	
$E_{AS}$	Single Pulse Avalanche Energy <sup>3</sup>	270	mJ
$P_D$	Power Dissipation, $T_C=25^\circ C$ <sup>4</sup>	48	W
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	°C

## Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{eJC}$	Thermal Resistance,Junction to Case <sup>1</sup>	1.71	°C/W
$R_{eJA}$	Thermal Resistance,Junction to Ambient <sup>1</sup>	62.5	

**Electrical Characteristics:** ( $T_C=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250 \mu\text{A}$	400	---	---	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{GS}=0\text{V}, V_{DS}=400\text{V}$	---	---	1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{GS}=\pm 30\text{V}, V_{DS}=0\text{A}$	---	---	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	GATE-Source Threshold Voltage	$V_{GS}=V_{DS}, I_D=250 \mu\text{A}$	2	---	4	V
$R_{DS(\text{ON})}$	Drain-Source On Resistance <sup>2</sup>	$V_{GS}=10\text{V}, I_D=3\text{A}$	---	---	1000	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=0\text{A}$	---	---	---	
$G_{FS}$	Forward Transconductance	$V_{DS}=10\text{V}, I_D=0\text{A}$	---	---	---	S
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS}=25\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$	---	480	610	pF
$C_{oss}$	Output Capacitance		---	80	105	
$C_{rss}$	Reverse Transfer Capacitance		---	15	20	
<b>Switching Characteristics</b> <sup>3,4</sup>						
$t_{d(on)}$	Turn-On Delay Time	$V_{DD}=200\text{V}, I_D=6\text{A}, V_{GS}=10\text{V}, R_{\text{GEN}}=25\Omega$	---	---	35	ns
$t_r$	Rise Time		---	---	140	ns
$t_{d(off)}$	Turn-Off Delay Time		---	---	5	ns
$t_f$	Fall Time		---	---	85	ns
$Q_g$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=320\text{V}, I_D=6\text{A}$	---	---	20	nC
$Q_{gs}$	Gate-Source Charge		---	.3	---	nC
$Q_{gd}$	Gate-Drain "Miller" Charge		---	6.4	---	nC
<b>Drain-Source Diode Characteristics</b>						
$V_{SD}$	Source-Drain Diode Forward Voltage	$V_{GS}=0\text{V}, I_S=5.5\text{A}$	---	---	1	V

<b>Ls</b>	Continuous Source Current	---	---	80	A
<b>Ism</b>	Pulsed Source Current	---	---	160	A
<b>trr</b>	Reverse Recovery Time <sup>3</sup>	$S=6A, V_{GS}=0V$ $di_F/dt=100A/\mu s$ (Note3)	14	---	Ns
<b>qrr</b>	Reverse Recovery Charge <sup>3</sup>		5	---	nc

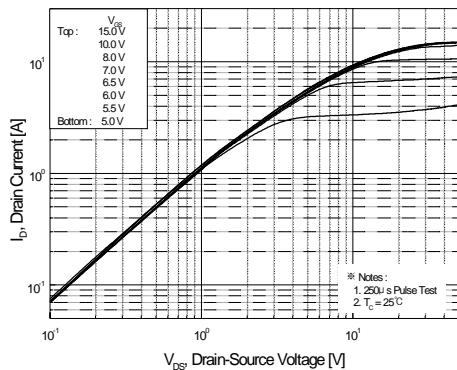
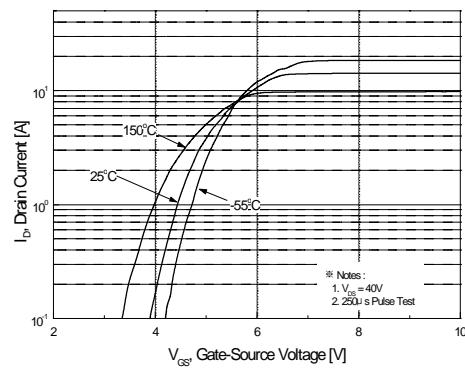
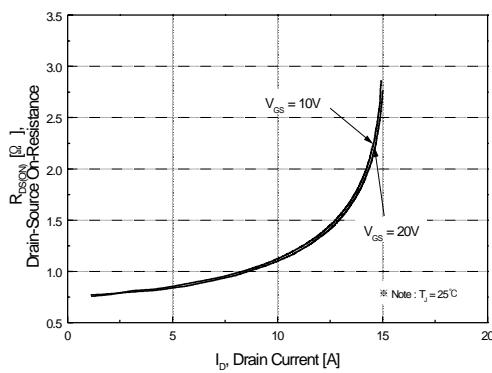
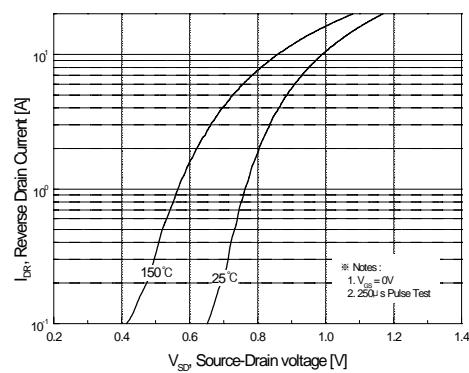
**Notes:**

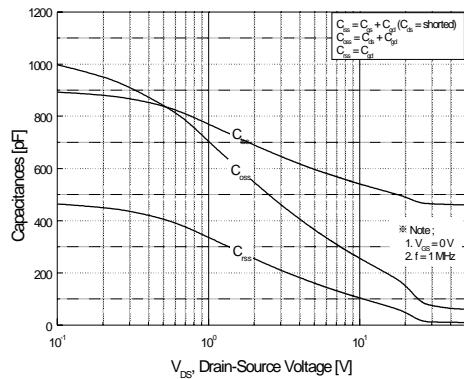
1, L=17.9mH, IAS=5.5A, VDD=50V, RG=25Ω, Starting TJ =25°C

2, Repetitive Rating : Pulse width limited by maximum junction temperature

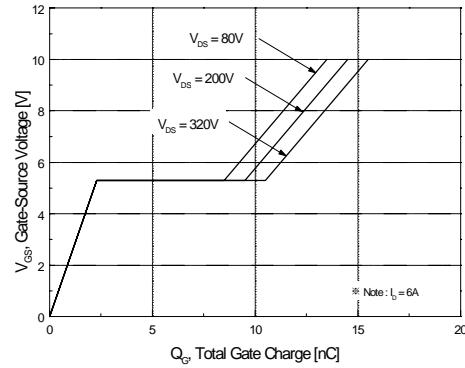
3, Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 2%

4, Essentially Independent of Operating Temperature

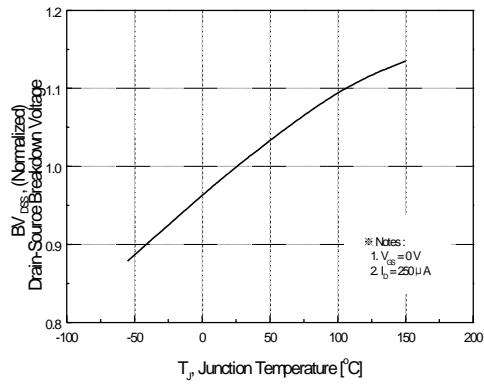
**Typical Characteristics:** (T<sub>c</sub>=25°C unless otherwise noted)

**Figure 1. On-Region Characteristics**

**Figure 2. Transfer Characteristics**

**Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage**

**Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature**



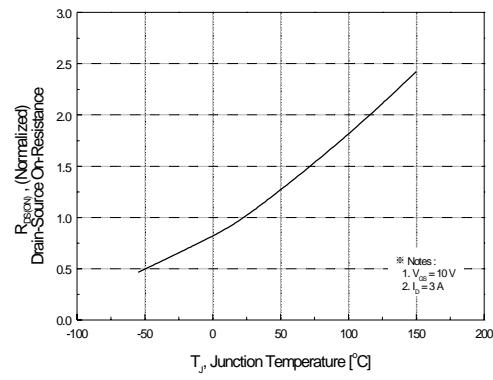
**Figure 5. Capacitance Characteristics**



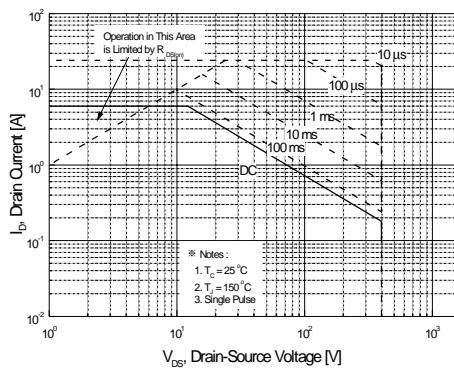
**Figure 6. Gate Charge Characteristics**



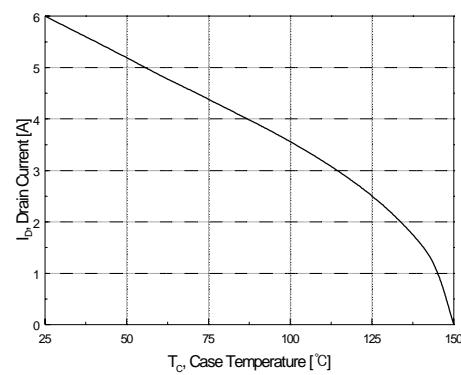
**Figure 7. Breakdown Voltage Variation vs Temperature**



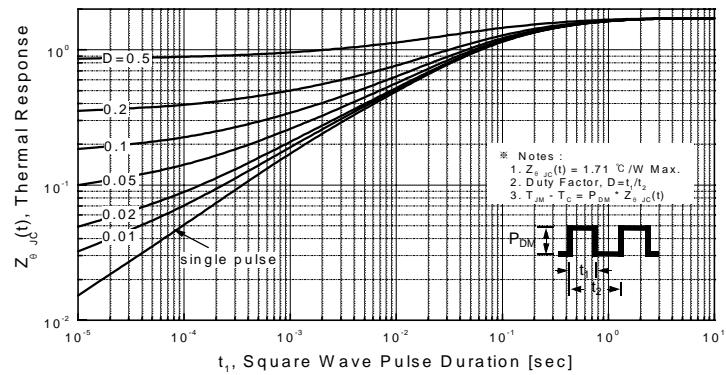
**Figure 8. On-Resistance Variation vs Temperature**



**Figure 9-1. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs Case Temperature**



**Figure 11-1. Transient Thermal Response Curve**



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